



GP201208-CTC3

SMD Type Green Emitter

Features

- Top view 0805 package
- Viewing Angle = $\pm 70^\circ$
- Compatible with infrared and vapor phase reflow solder process
- High reliability
- Ultra bright Green
- RoHS compliance

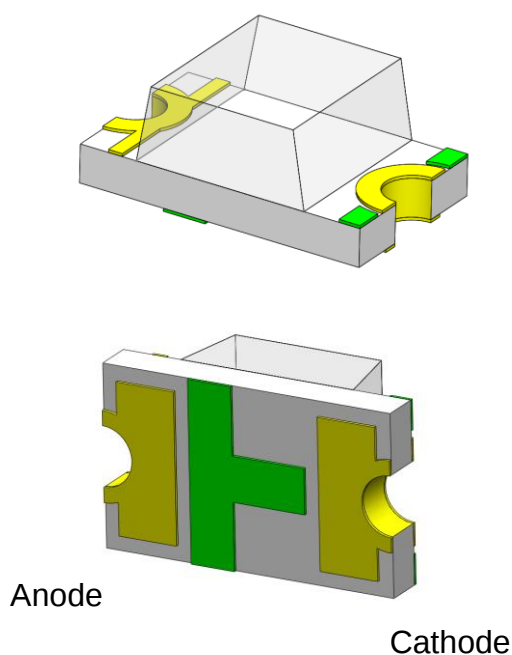
Applications

- Optical indicator.
- Switch and Symbol Display.

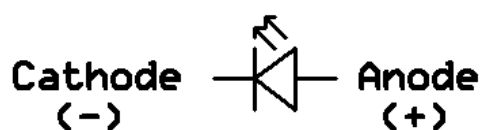
Description

The GP201208-CTC3 is an AlGaInP Green LED housed in a miniature SMD package. The device has a dominant wavelength of 525 nm LED.

Package Outline



Schematic





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Absolute Maximum Rating at 25°C

Symbol	Parameters	Ratings	Units	Notes
I _F	Continuous Forward Current	25	mA	
I _{FP}	Peak Forward Current	60	mA	1
V _R	Reverse Voltage	5	V	
T _{opr}	Operating Temperature	-40 ~ +85	°C	
T _{stg}	Storage Temperature	-40 ~ +100	°C	
T _{sol}	Soldering Temperature	260	°C	2
P _D	Power Dissipation at(or below) 25°C Free Air Temperature	95	mW	

Electro-Optical Characteristics *TA = 25°C (unless otherwise specified)*

Optical Characteristics

Symbol	Parameters	Test Conditions	Min	Typ	Max	Units	Notes
I _v	Luminous Intensity	I _F =5mA	160	-	400	mcd	3
λ _d	Dominant Wavelength	I _F =5mA	520	-	535	nm	4
θ _{1/2}	Angle of Half Intensity	I _F =5mA	-	±70	-	deg	

Electrical Characteristics

Symbol	Parameters	Test Conditions	Min	Typ	Max	Units	Notes
V _F	Forward Voltage	I _F =5mA	2.5	-	3.0	V	5
I _R	Reverse Current	V _R =5V	-	-	1	μA	

Notes:

1. I_{FP} Conditions--Pulse Width ≤ 100μs and Duty ≤ 10%.
2. Soldering time ≤ 10 seconds.
3. Bin Range of Luminous Intensity

Bin Code	Min	Max	Unit	Condition
o2	160	200	mcd	I _F =5mA
p1	200	250		
p2	250	300		
q1	300	350		
q2	350	400		

Tolerance of: Luminous Intensity ±10%



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4. Bin Range of Dominant Wavelength

Bin Code	Min	Max	Unit	Condition
A5	520	525	nm	$I_F=5mA$
A6	525	530		
A7	530	535		

Tolerance of Dominant Wavelength: $\pm 1nm$.

5. Bin Range of Forward Voltage

Bin Code	Min	Max	Unit	Condition
32	2.5	2.6	V	$I_F=5mA$
33	2.6	2.7		
34	2.7	2.8		
35	2.8	2.9		
36	2.9	3.0		

Tolerance of Forward Voltage $\pm 0.05V$.



Typical Characteristic Curves

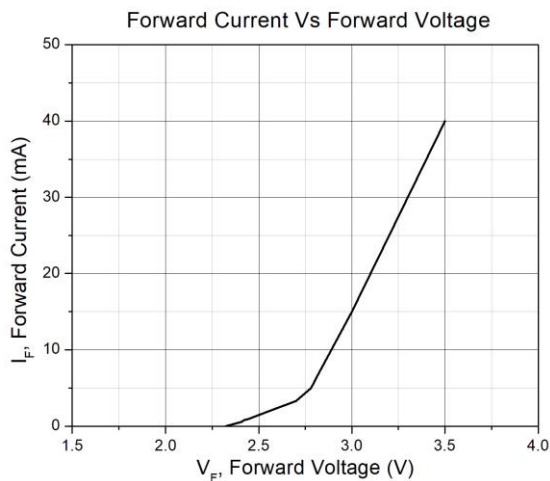


Figure 1

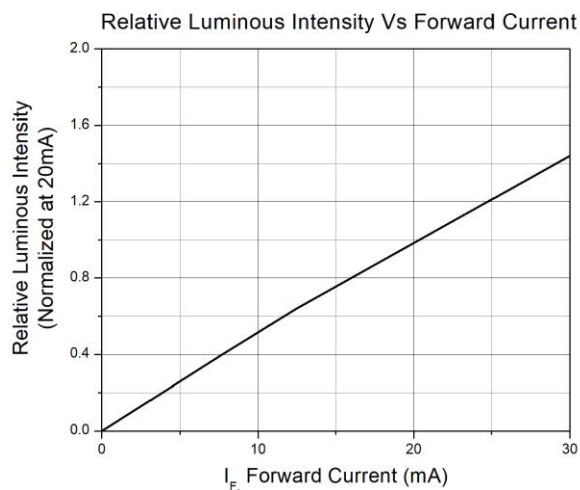


Figure 2

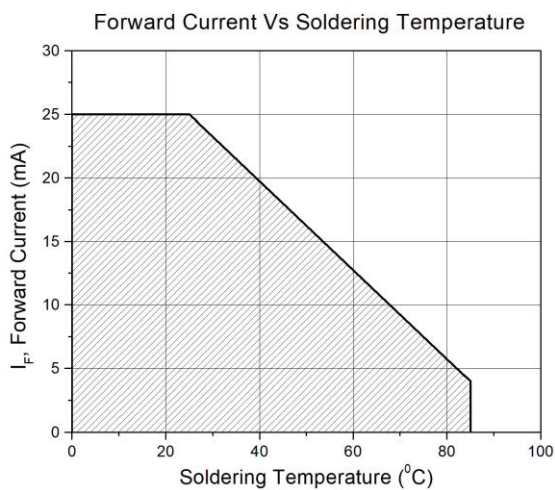


Figure 3

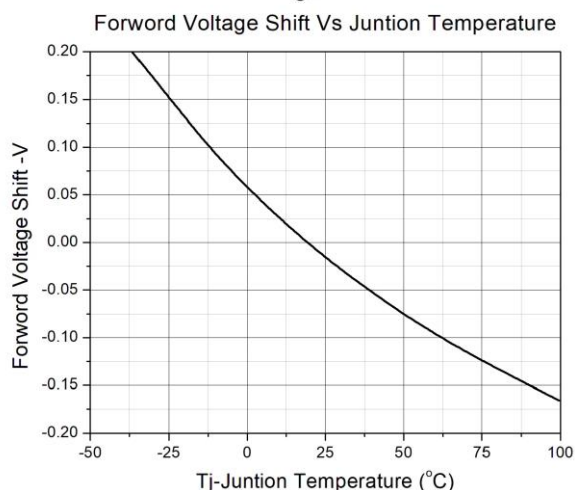


Figure 4

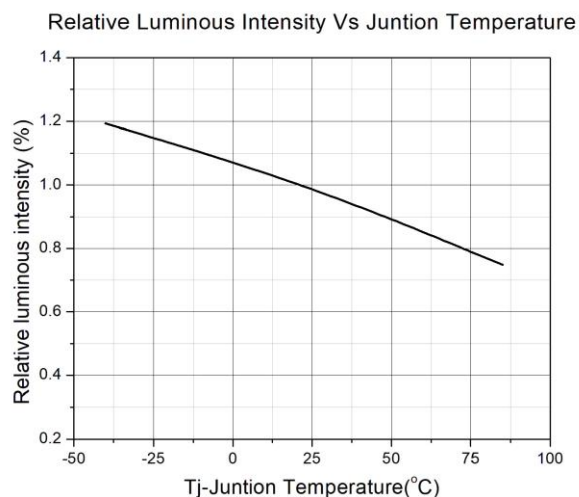


Figure 5

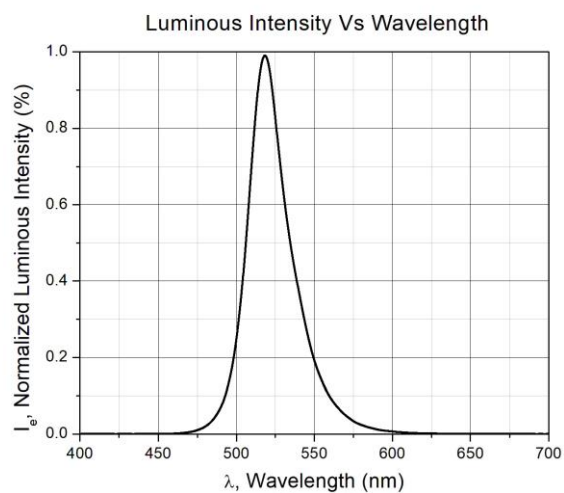
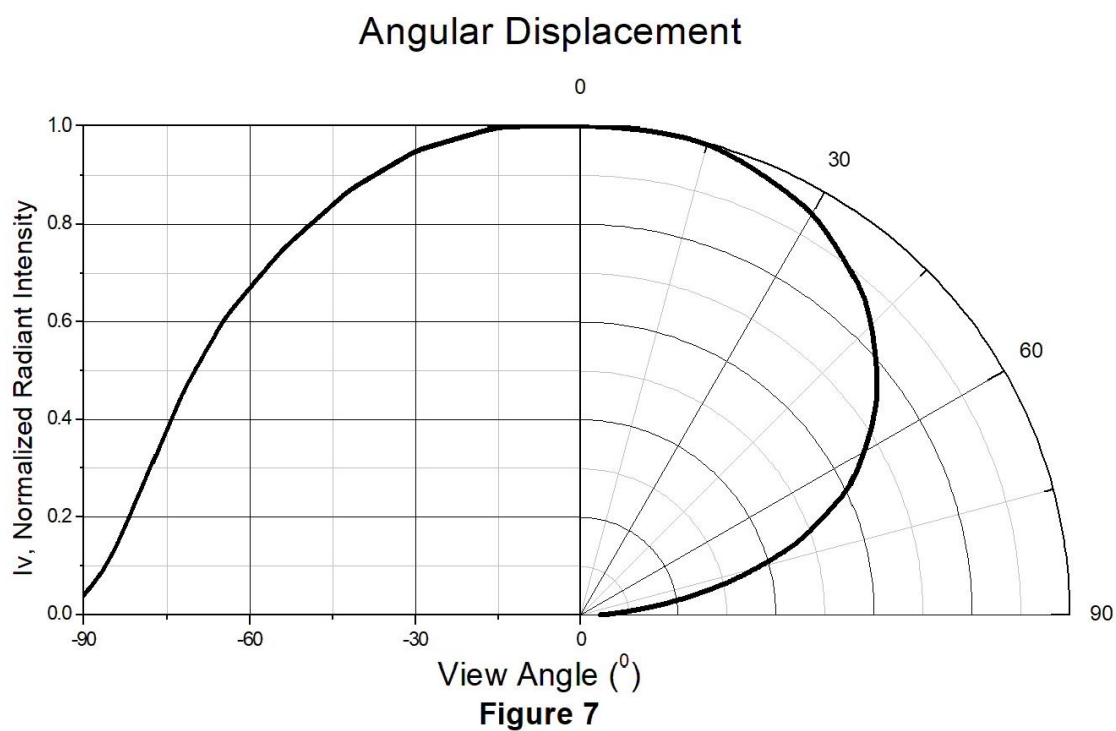


Figure 6



Typical Characteristic Curves





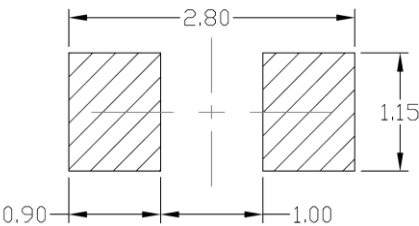
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Package Dimension *All dimensions are in mm, unless otherwise stated*



Note: Tolerance unless mentioned is $\pm 0.1\text{mm}$.

Recommended Soldering Mask



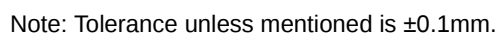
Note: Tolerance unless mentioned is $\pm 0.1\text{mm}$.

Ordering Information

<i>Part Number</i>	<i>Description</i>	<i>Quantity</i>
GP201208-CTC3	Tape & Reel	3000 pcs



Reel Dimension *All dimensions are in mm, unless otherwise stated*





GP201208-CTC3

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Label Form Specification

CT Micro
International Corporation

MSL-X
MADE IN CHINA

CPN: XXXXXXXXXXXXXXXXXXXX
|||||

Part no: XXXXXXXXXXXXXXXX
|||||

Serial no: XXXXXXXX
|||||

Lot no: XXXXXXXX
|||||

Qty: XXXXXX Date Code: YWWJ
|||||

IV: XX WD:XX VF:XX
|||||

QR Code

Pb
RoHS

CPN : Customer Part Number

Part no: CTM Production Number

Serial no: Production Number

Lot no: Lot number

Q'ty: Packing Quantity

Date Code: Manufacture Date

IV : Bin Code of Luminous Intensity

WD : Bin Code of Dominant Wavelength

VF : Bin Code of Forward Voltage

MADE IN CHINA: Production Place

Storage Condition

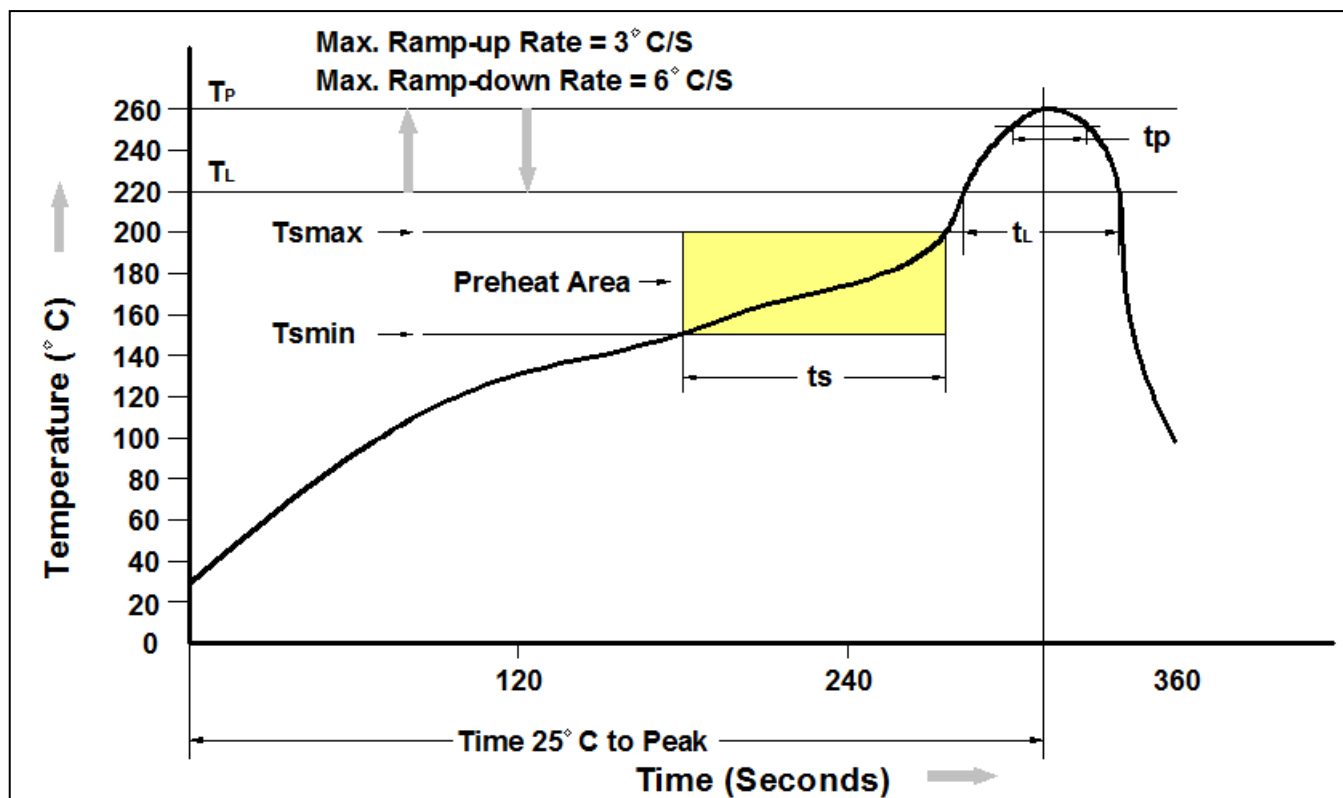
1. Do not open moisture proof bag before the products are ready to use.
2. The moisture barrier bag should be stored at 30°C and 90%R.H. max. before opening.
Shelf life of non-opened bag is 12 months after the bag sealing date.
3. After opening the moisture barrier bag floor life is 1 year at 30°C/60%RH. max. Unused LEDs should be resealed into moisture barrier bag. (Refer to J-STD-020 Standard)
4. If the moisture absorbent material has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the J-STD-033 Standard conditions.



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Reflow Profile



Profile Feature	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	150°C
Temperature Max. (Tsmax)	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds
Ramp-up Rate (tL to tP)	3°C/second max.
Liquidous Temperature (TL)	217°C
Time (tL) Maintained Above (TL)	60 – 150 seconds
Peak Body Package Temperature	260°C +0°C / -5°C
Time (tP) within 5°C of 260°C	30 seconds
Ramp-down Rate (TP to TL)	6°C/second max
Time 25°C to Peak Temperature	8 minutes max.



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